



6427525 N E C ELECTRONICS INC

98D 18966 D 7-39-11

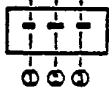
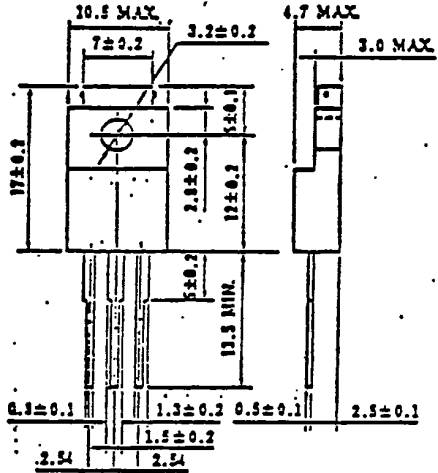
MOS FIELD EFFECT TRANSISTOR

2SK811

**FAST SWITCHING
N-CHANNEL SILICON POWER MOS FET**

PACKAGE DIMENSIONS

(Unit: mm)



- 1. Gate
- 2. Drain
- 3. Source

Features

- Suitable for switching power supplies, actuator controls and pulse circuits
- 4V Gate Drive — Logic level —
- Large Current Switching : $I_D(DC)=12A$
- Low $R_{DS(on)}$
- No second breakdown

Absolute Maximum Ratings ($T_a=25^\circ C$)

Drain to Source Voltage	V_{DS}	100V
Gate to Source Voltage	V_{GS}	$\pm 20V$
Continuous Drain Current	$I_D(DC)$	$\pm 12A$
Pulse Drain Current	$I_D(pulse)$	$* \pm 48A$
Total Power Dissipation	P_T	2.0W
Total Power Dissipation	P_{T*}	35W
Channel Temperature	T_{ch}	150 °C
Storage Temperature	T_{stg}	-55to+150 °C
	* $T_{ch} \leq 150^\circ C$	
	** $T_c = 25^\circ C$	

Electrical Characteristics ($T_a=25^\circ C$)

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain Leakage Current	I_{DSS}			10	μA	$V_{DS}=100V, V_{GS}=0$
Gate to Source Leakage Current	I_{GSS}			100	nA	$V_{GS}=20V, V_{DS}=0$
Gate to Source Cutoff Voltage	$V_{GS(off)}$	1.0		2.5	V	$V_{DS}=10V, I_D=1.0mA$
Forward Transfer Admittance	$ y_{fs} $	4.0	10		S	$V_{DS}=10V, I_D=8.0A$
Drain to Source On-State Resistance	$R_{DS(on)}$		0.1	0.18	Ω	$V_{GS}=10V, I_D=8.0A$
Drain to Source On-State Resistance	$R_{DS(on)}$		0.15	0.25	Ω	$V_{GS}=4.0V, I_D=8.0A$
Input Capacitance	C_{iss}		1200		pF	$V_{DS}=10V, V_{GS}=0,$
Output Capacitance	C_{oss}		400		pF	$f=1.0MHz$
Reverse Transfer Capacitance	C_{rss}		90		pF	$I_D=8.0A,$
Turn-On Delay Time	$t_{d(on)}$		10		ns	$V_{GS(on)}=10V,$
Rise Time	t_r		20		ns	$V_{CC}=40V,$
Turn-Off Delay Time	$t_{d(off)}$		65		ns	$R_L=5.0\Omega$
Fall Time	t_f		55		ns	

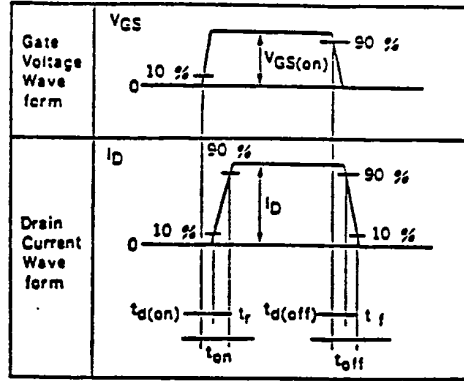
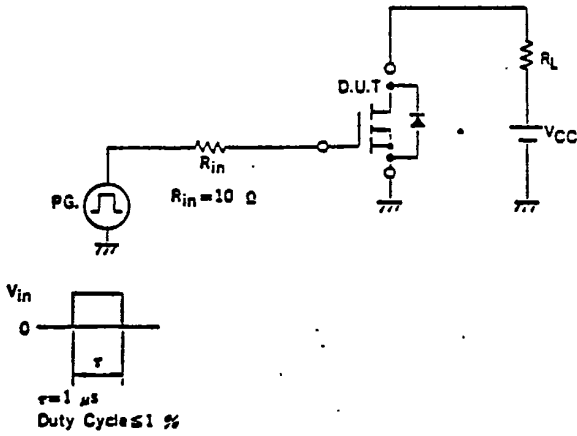
NEC cannot assume any responsibility for any circuits shown or represent that they are free from patent infringement.

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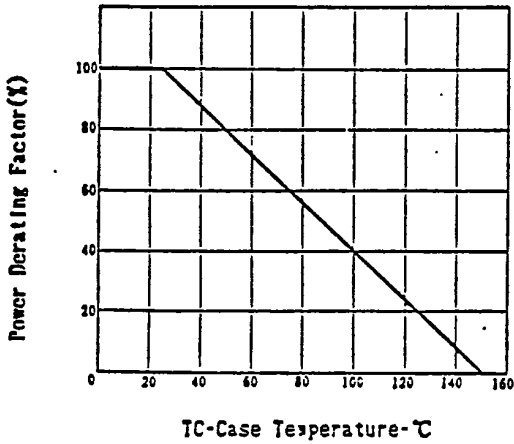
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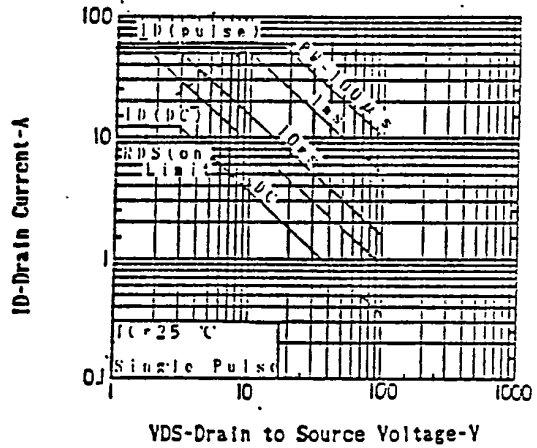
TURN-ON AND TURN-OFF TIME TEST CIRCUIT



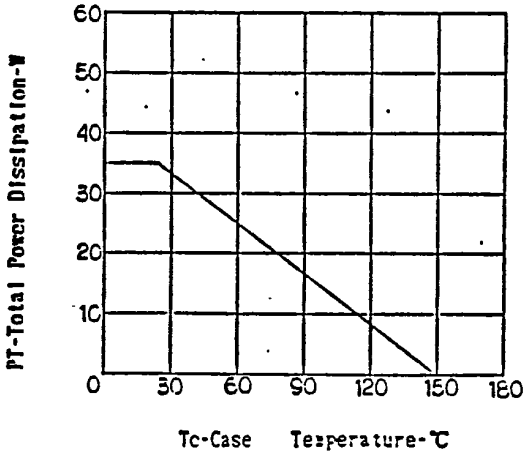
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



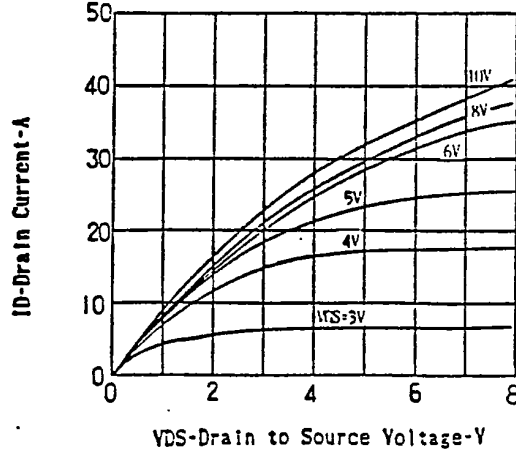
FORWARD BIAS SAFE OPERATING AREA



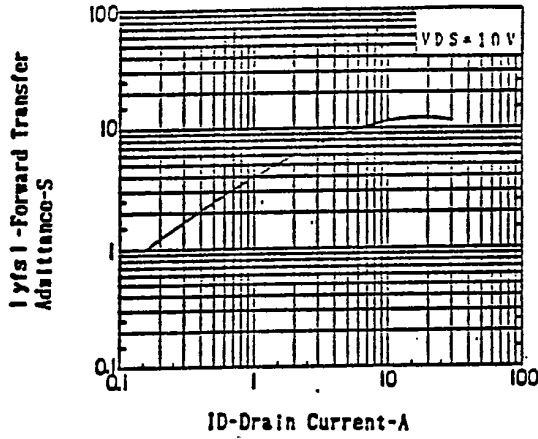
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



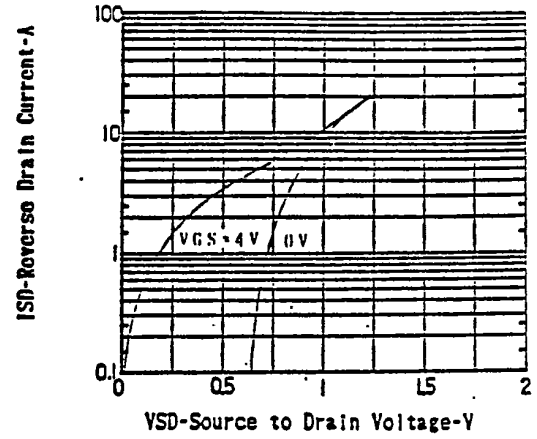
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



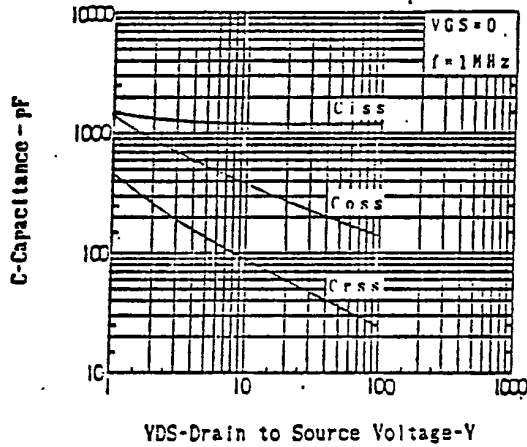
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



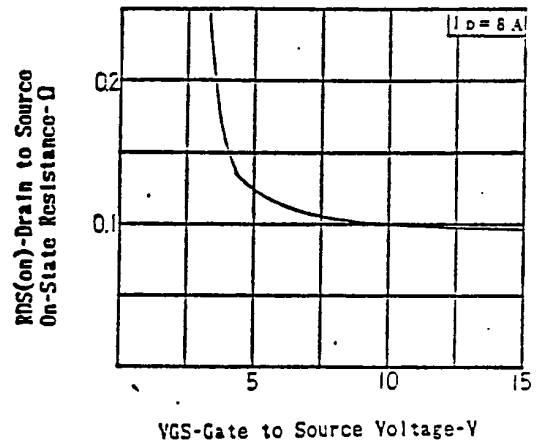
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



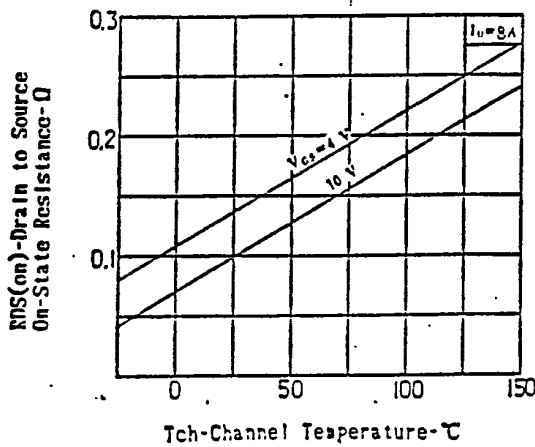
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



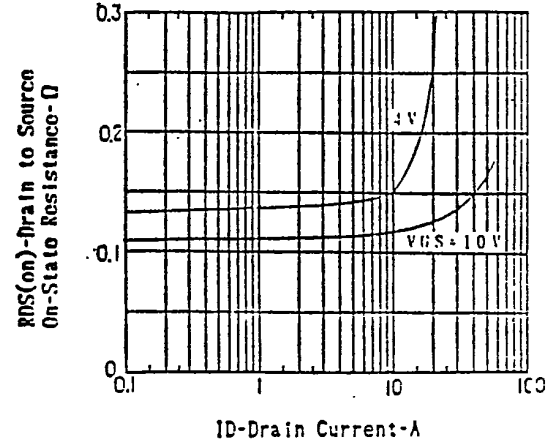
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



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